Ultrafast Transient Liquid Assisted Frowth of YBa₂Cu₃O₇: A New Scenario for Enhanced Vortex Pinning

<u>Xavier Obradors</u>¹, Teresa Puig¹, Juri Banchewski¹, Silvia Rasi^{1,2}, Kapil Gupta¹, Albert Queralto¹, Lavinia Saltarelli¹, Diana Garcia^{1, 3}, Adria Pacheco¹, Valentina R. Vlad¹, Aiswarya Kethamkuzhi¹, Laia Soler¹, Julia Jareño¹, Natalia Chamorro^{3,1}, Joffre Gutierrez¹, Susagna Ricart¹, Cristian Mocuta⁴, and Jordi Farjas²

¹ Institut de Ciència de Materials de Barcelona, ICMAB-CSIC, Catalonia, Spain
² GRMT, Dept. of Physics, University of Girona, Catalonia, Spain
³ Dep. de Química, Univ. Autonoma de Barcelona, Catalonia, Spain
⁴ Diffabs beamline, Soleil Synchrotron, Paris, France

E-mail: obradors@icmab.es

Abstract-High current superconducting wires have been one of the most challenging achievements during all the HTS era which encompasses many materials science and engineering challenges. Coated conductors of REBa₂Cu3O₇ (CC-REBCO, RE= Rare Earth) have emerged as the most attractive opportunity to reach unique performances at high and low temperatures, while reducing the cost/performance ratio continues to be a key objective for their marketability. Chemical solution deposition (CSD) is a very competitive costeffective deposition technique which has been used to obtain nanocomposite films and CCs, however their growth rates is rather small (0.5-1 nm/s) when the BaF₂ route is used. To address this challenge, we are developing a novel growth approach, entitled Transient Liquid Assisted Growth (TLAG) [1], which is able to combine CSD of non-fluorine precursors with ultrahigh growth rates mediated by a non-equilibrium transient liquid (100-1000 nm/s), being compatible with nanocomposite structures including BaMO₃ (M=Zr, Hf) nanoparticles [2,3]. High critical current densities have been achieved up of 5 MA/cm2 at 77K are already realized in thin films, and now the process is being transferred to thicker films and metallic substrates. In this presentation, we will discuss on the present understanding of the TLAG process, the correlations of the new microstructure with vortex pinning and the capacity of TLAG to modify the pinning landscape. The use of fast acquisition in-situ XRD imaging (100 ms/frame) under synchrotron radiation, transmission electron microscopy, in-situ resistivity experiments and angular transport measurements have been crucial for this study.

Keywords (Index Terms)—Coated conductor; YBa₂Cu₃O₇; Chemical Solution Deposition; Transient Liquid Assisted Growth; critical currents; vortex pinning; nanocomposite

We acknowledge funding from EU-ERC_AdG-2014-669504 ULTRASUPERTAPE and EU-PoC-2020-IMPACT projects, and the Excellence Program Severo Ochoa SEV2015- 0496.

[1] L. Soler et al, Nature Communications, 11, 344 (2020)

[2] S. Rasi et al, J. Phys. Chem. C, 124, 15574 (2020)

[3] A. Queraltó et al, ACS Appl. Mater. Interfaces, 13, 9101 (2021)

IEEE CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), March 2023

IEEE-CSC & ESAS SUPERCONDUCTIVITY NEWS FORUM (global edition), March 2023. Presentation 3MOr2A-01 was given at Applied Superconductivity Conference, Honolulu, HI, USA, October 26, 2022.